

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

0753414477

Status:

Active

Overview:

gbx_backplane_connector_system

Description:

1.85mm by 1.85mm (.073 by .073") Pitch 4-Pair GbX® Backplane Connector System, Power Module, 12 Circuits, 1.27µm (50µ") Gold (Au)

Documents:

Drawing (PDF)

RoHS Certificate of Compliance (PDF)

Product Specification PS-75221-999 (PDF)

Agency Certification

UL

E29179

General

Product Family

Backplane Connectors

Series

75341

Application

Backplane

Application Tooling Documents

Tooling Manual

Comments

Blade Length A 4.50mm, B 4.50mm, C 7.50mm, D 7.50mm

Component Type

Power Header

Overview

gbx_backplane_connector_system

Product Name

GbX®

Style

N/A

Physical

Circuits (Loaded)

8

Circuits (maximum)

8

Circuits Detail

Rows A, B, C, & D

Color - Resin

Gray

Durability (mating cycles max)

200

First Mate / Last Break

Yes

Flammability

94V-0

Guide to Mating Part

No

Keying to Mating Part

None

Material - Plating Mating

Gold

Material - Plating Termination

Tin-Lead

Material - Resin

High Temperature Thermoplastic

Number of Columns

N/A

Number of Pairs

4

Number of Rows

4

Orientation

Vertical

PC Tail Length (in)

0.089 In

PC Tail Length (mm)

2.28 mm

PCB Locator

Yes

PCB Retention

Yes

PCB Thickness Recommended (in)

0.063 In

PCB Thickness Recommended (mm)

1.60 mm

Packaging Type

Tube

Pitch - Mating Interface (in)

0.073 In

Pitch - Mating Interface (mm)

1.85 mm

Pitch - Term. Interface (in)

0.102 In

Pitch - Term. Interface (mm)

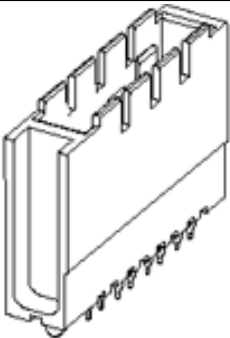
2.60 mm

Plating min: Mating (µin)

50

Plating min: Mating (µm)

1.25



Series

image - Reference only

EU RoHS

RoHS Compliant by Exemption

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

China RoHS



Pb

Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

75341Series

Mates With

75292 GbX® Daughtercard

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
Insertion Module, GbX® 4 pair 1- Up Power Module	0622022005
GbX® Single Pin Repair Tool	0622022090
GbX® Shield Removal Tool	0622022100

Plating min: Termination (μin)	30
Plating min: Termination (μm)	0.75
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	6A
Data Rate	8.0 Gbps
Real Signals (per 25mm)	0
Shielded	No
Voltage - Maximum	120V AC (RMS)/DC

Material Info

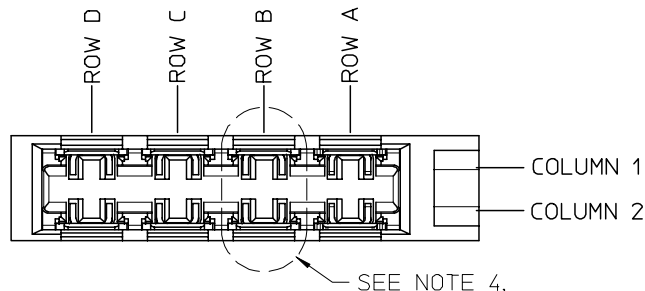
Reference - Drawing Numbers

Product Specification	PS-75221-999
Sales Drawing	SD-75341-001

GbX is a registered trademark of Amphenol Corporation.

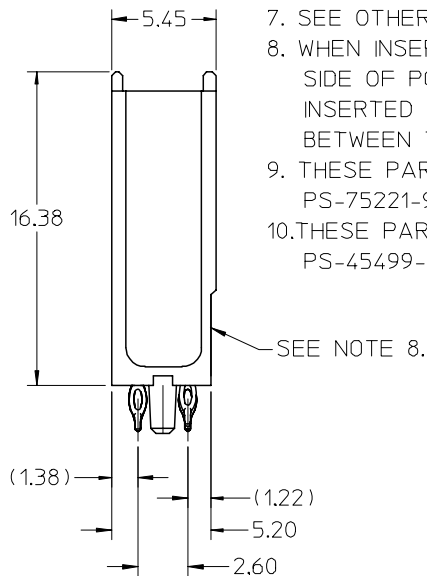
This document was generated on 05/13/2010
PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

10 9 8 7 6 5 4 3 2 1



NOTES:

1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), UL 94V-0, GRAY; CONTACT - COPPER ALLOY.
2. FINISH: SELECT GOLD IN CONTACT AREA, 50 μ " THICK; TIN/LEAD OR MATTE TIN IN COMPLIANT AREA.
3. PACKAGING PER PK-70873-562.
4. CONTACTS IN EACH ROW HAVE THE SAME WIPE LENGTH.
5. BACKPLANE ASSEMBLY MATES WITH DAUGHTERCARD POWER MODULE 75292-4***.
6. PART SHOWN IS 75343-4467 (SHEET 4).
7. SEE OTHER SHEETS FOR ADDITIONAL NOTES.
8. WHEN INSERTING OPEN SIGNAL MODULES NEXT TO COLUMN 1 SIDE OF POWER MODULES, SIGNAL MODULES MUST BE INSERTED BEFORE THE POWERS TO AVOID INTERFERENCE BETWEEN THE TWO CONNECTOR HOUSINGS.
9. THESE PARTS CONFORM TO MOLEX PRODUCT SPECIFICATION PS-75221-999.
10. THESE PARTS CONFORM TO MOLEX COSMETIC SPECIFICATION PS-45499-002 CLASS B.



1-UP ASSEMBLY PART NUMBER

7 5 3 4 1 - A B C D
- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:
0 = VOID
4 = 4.5 mm WIPE
6 = 6.0 mm WIPE
7 = 7.5 mm WIPE
- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:
0 = VOID
2 = 4.5 mm WIPE
3 = 6.0 mm WIPE
5 = 7.5 mm WIPE

ADDED NOTES 9 & 10 EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J.B. INGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
					DRAWN BY ELO	DATE 2006/04/06	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED		
					CHECKED BY ELO	DATE 2005/02/22			
					APPROVED BY CUNNINGHAM	DATE 2005/02/23			
			MATERIAL NO.		DOCUMENT NO.				
		REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE B		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

9 8 7 6 5 4 3 2 1

10 9 8 7 6 5 4 3 2 1



2-UP ASSEMBLY PART NUMBER

7 5 3 4 2 - A B C D

- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID
4 = 4.5 mm WIPE
6 = 6.0 mm WIPE
7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID
2 = 4.5 mm WIPE
3 = 6.0 mm WIPE
5 = 7.5 mm WIPE



SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: J. BINGHAM 2007/08/30 APPR: J. BINGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)				DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm		INCH		DRAWN BY ELO	DATE 2006/04/06	GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED				
			4 PLACES	± ---	± ---	CHECKED BY ELO	DATE 2005/02/22						
			3 PLACES	± ---	± ---	APPROVED BY CUNNINGHAM 2005/02/23							
			2 PLACES	± ---	± ---								
			1 PLACE	± ---	± ---								
			ANGULAR ± ---°				MATERIAL NO.	DOCUMENT NO.	SHEET NO. 2 OF 4				
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				SEE CHART		SD-75341-001				
			REV	C	SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

9 8 7 6 5 4 3 2 1



COLUMN 1
COLUMN 2
COLUMN 3
COLUMN 4
COLUMN 5
COLUMN 6

SEE NOTE 4.



14.80

3-UP ASSEMBLY PART NUMBER

7 5 3 4 3 - A B C D

- TIN/LEAD PLATED PRODUCT -

FOR EACH ROW LOCATION A, B, C, D:

0 = VOID

4 = 4.5 mm WIPE

6 = 6.0 mm WIPE

7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -

FOR EACH ROW LOCATION A, B, C, D:

0 = VOID

2 = 4.5 mm WIPE

3 = 6.0 mm WIPE

5 = 7.5 mm WIPE



SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: BINGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY ELO	DATE 2006/04/06	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY				
			4 PLACES	± ---	± ---	CHECKED BY	DATE					
			3 PLACES	± ---	± ---	ELO	2005/02/22					
			2 PLACES	± ---	± ---	APPROVED BY	DATE					
			1 PLACE	± ---	± ---	CUNNINGHAM	2005/02/23	 MOLEX INCORPORATED				
			ANGULAR ± ---°		MATERIAL NO.		DOCUMENT NO.					
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-75341-001			SHEET NO. 3 OF 4		
			REV	C	SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



SEE NOTE 5.

6.0 mm WIPE
7.5 mm WIPE
4.5 mm WIPE

0.76
DC BOARD EDGE TO
CENTERLINE OF BP TAIL

0.15

HOLE PATTERN FOR 1-UP ASSEMBLY

- 1.) ADD 7.40 FROM CENTERLINES OF PEGS FOR MULTIPLE UP ASSEMBLIES.
- 2.) ADD 5.55 FROM CENTERLINE TO CENTERLINE OF PEG FOR INDIVIDUAL POWER MODULES STACKED NEXT TO EACH OTHER.



ADDED $\phi 0.74 \pm 0.06$ EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J. BINGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
			mm	INCH	DRAWN BY ELO	DATE 2006/04/06	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY				
		4 PLACES	± ---	± ---	CHECKED BY ELO	DATE 2005/02/22					
		3 PLACES	± ---	± ---	APPROVED BY CUNNINGHAM		DATE 2005/02/23	MOLEX MOLEX INCORPORATED			
		2 PLACES	± ---	± ---							
		1 PLACE	± ---	± ---	MATERIAL NO.		DOCUMENT NO.	SHEET NO.			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE PREVIOUS		SD-75341-001			4 OF 4			
C	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9